Switching Transistor

NPN Silicon

Features

• Moisture Sensitivity Level: 1

• ESD Rating: Human Body Model; 4 kV,

Machine Model; 400 V

• These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS

Compliant

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CEO}	40	Vdc
Collector-Base Voltage	V _{CBO}	60	Vdc
Emitter-Base Voltage	V _{EBO}	6.0	Vdc
Collector Current – Continuous	Ic	600	mAdc

THERMAL CHARACTERISTICS

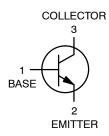
Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board T _A = 25°C	P _D	150	mW
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	833	°C/W
Junction and Storage Temperature	T _J , T _{stg}	-55 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



ON Semiconductor®

http://onsemi.com





SC-70 (SOT-323) CASE 419 STYLE 3

MARKING DIAGRAM



(Note: Microdot may be in either location)

*Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]
MMBT4401WT1G	SC-70 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Chara	Symbol	Min	Max	Unit		
OFF CHARACTERISTICS				•	•	
Collector-Emitter Breakdown Voltage (Note	V _{(BR)CEO}	40	-	Vdc		
Collector-Base Breakdown Voltage (I _C = 0	V _{(BR)CBO}	60	-	Vdc		
Emitter-Base Breakdown Voltage (I _E = 0.1	V _{(BR)EBO}	6.0	-	Vdc		
Base Cutoff Current (V _{CE} = 35 Vdc, V _{EB} = 0	I _{BEV}	_	0.1	μAdc		
ON CHARACTERISTICS (Note 1)				•	•	
DC Current Gain $ \begin{aligned} &(I_C = 0.1 \text{ mAdc, } V_{CE} = 1.0 \text{ Vdc)} \\ &(I_C = 1.0 \text{ mAdc, } V_{CE} = 1.0 \text{ Vdc)} \\ &(I_C = 10 \text{ mAdc, } V_{CE} = 1.0 \text{ Vdc)} \\ &(I_C = 150 \text{ mAdc, } V_{CE} = 1.0 \text{ Vdc)} \\ &(I_C = 500 \text{ mAdc, } V_{CE} = 2.0 \text{ Vdc)} \end{aligned} $		h _{FE}	20 40 80 100 40	- - - 300 -	-	
Collector – Emitter Saturation Voltage (I_C = 150 mAdc, I_B = 15 mAdc) (I_C = 500 mAdc, I_B = 50 mAdc)	V _{CE(sat)}	_ _	0.4 0.75	Vdc		
Base – Emitter Saturation Voltage (I_C = 150 mAdc, I_B = 15 mAdc) (I_C = 500 mAdc, I_B = 50 mAdc)	V _{BE(sat)}	0.75 -	0.95 1.2	Vdc		
Collector Cutoff Current (V _{CE} = 35 Vdc, V _{EI}	I _{CEX}	_	0.1	μAdc		
SMALL-SIGNAL CHARACTERISTICS						
Current-Gain - Bandwidth Product (I _C = 20	0 mAdc, V _{CE} = 10 Vdc, f = 100 MHz)	f _T	250	-	MHz	
Collector-Base Capacitance (V _{CB} = 5.0 Vc	dc, I _E = 0, f = 1.0 MHz)	C _{cb}	=	6.5	pF	
Emitter-Base Capacitance (V _{EB} = 0.5 Vdc,	C _{eb}	=	30	pF		
Input Impedance ($I_C = 1.0 \text{ mAdc}$, $V_{CE} = 10$	h _{ie}	1.0	15	kΩ		
Voltage Feedback Ratio ($I_C = 1.0 \text{ mAdc}, V_C$	h _{re}	0.1	8.0	X 10 ⁻⁴		
Small-Signal Current Gain (I _C = 1.0 mAdc,	h _{fe}	40	500	-		
Output Admittance ($I_C = 1.0 \text{ mAdc}$, $V_{CE} = 1$	h _{oe}	1.0	30	μmhos		
SWITCHING CHARACTERISTICS						
Delay Time	(V _{CC} = 30 Vdc, V _{EB} = 2.0 Vdc,	t _d	=	15		
Rise Time	I _C = 150 mAdc, I _{B1} = 15 mAdc)	t _r	=	20	ns	
Storage Time	(V _{CC} = 30 Vdc, I _C = 150 mAdc,	t _s	-	225		
Fall Time	I _{B1} = I _{B2} = 15 mAdc)	t _f	_	30	ns	

^{1.} Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.

SWITCHING TIME EQUIVALENT TEST CIRCUITS

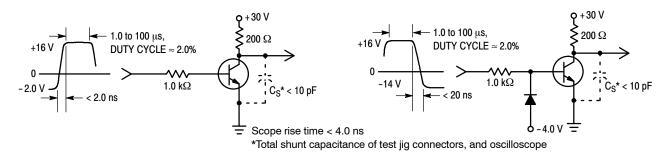
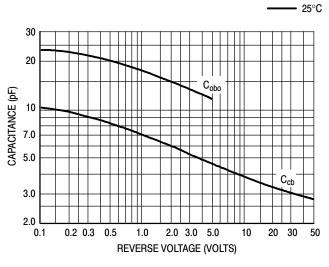


Figure 1. Turn-On Time

Figure 2. Turn-Off Time

TRANSIENT CHARACTERISTICS

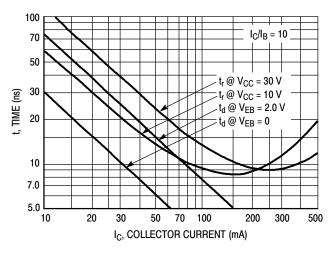
—— 100°C



10 7.0 $V_{CC} = 30 \text{ V}$ 5.0 $I_{\rm C}/I_{\rm B} = 10$ 3.0 2.0 Q, CHARGE (nC) 1.0 0.7 0.5 0.3 0.2 0.1 10 20 70 100 200 300 50 500 IC, COLLECTOR CURRENT (mA)

Figure 3. Capacitances

Figure 4. Charge Data



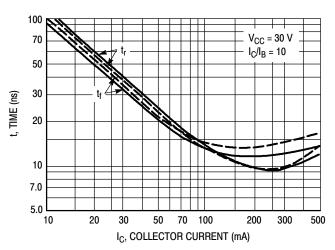
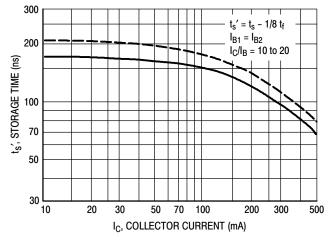


Figure 5. Turn-On Time

Figure 6. Rise and Fall Times



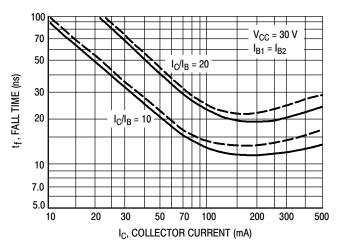


Figure 7. Storage Time

Figure 8. Fall Time

SMALL-SIGNAL CHARACTERISTICS NOISE FIGURE

 $V_{CE} = 10 \text{ Vdc}, T_A = 25^{\circ}\text{C}; Bandwidth = 1.0 \text{ Hz}$

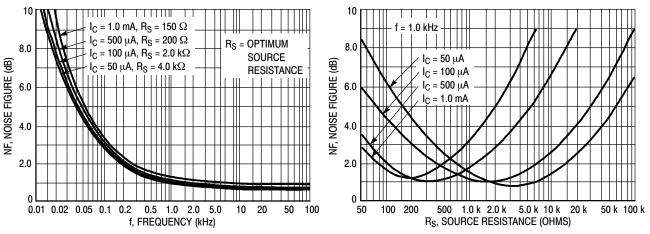


Figure 9. Frequency Effects

Figure 10. Source Resistance Effects

h PARAMETERS

 $V_{CE} = 10 \text{ Vdc}, f = 1.0 \text{ kHz}, T_A = 25^{\circ}\text{C}$

This group of graphs illustrates the relationship between h_{fe} and other "h" parameters for this series of transistors. To obtain these curves, a high-gain and a low-gain unit were selected from the MMBT4401WT1 lines, and the same units were used to develop the correspondingly numbered curves on each graph.

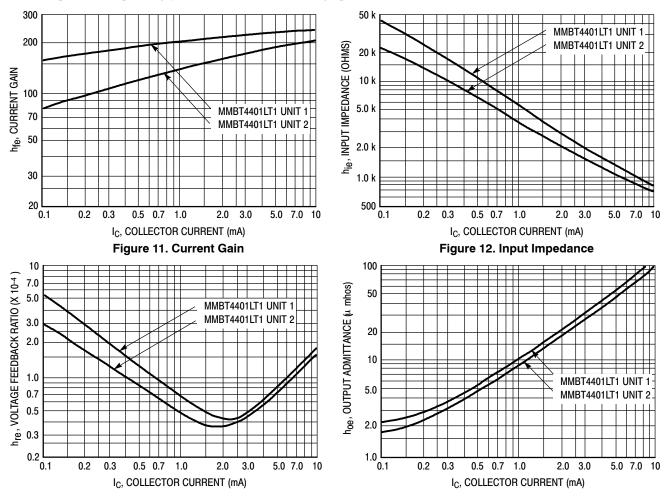
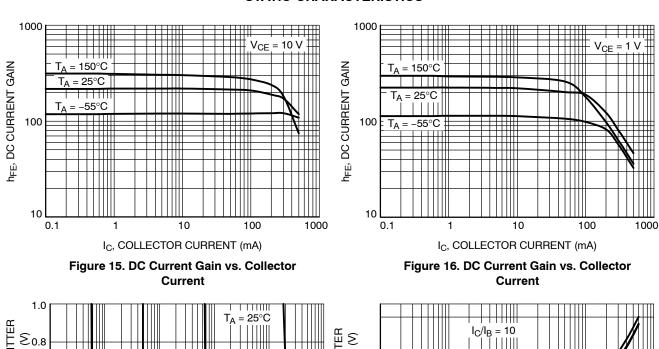


Figure 13. Voltage Feedback Ratio

Figure 14. Output Admittance

STATIC CHARACTERISTICS



V_{CE}(sat), COLLECTOR-EMITTER SATURATION VOLTAGE (V) S P 0 9 8 V_{CE}, COLLECTOR-EMITTER SATURATION VOLTAGE (V) = -55°C 100 mA I_C = 600 mA 10 mA V_{CE}, T_A = 150°C 0.02 0.001 0.01 10 100 0.1 10 1000 IB, BASE CURRENT (mA) IC, COLLECTOR CURRENT (mA)



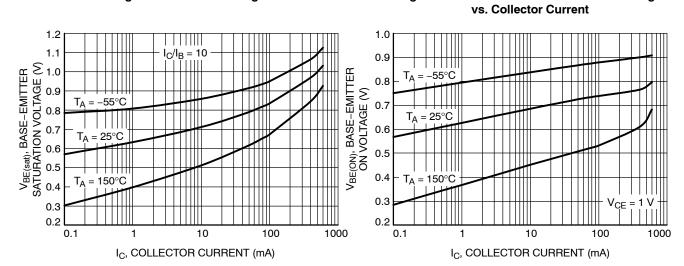
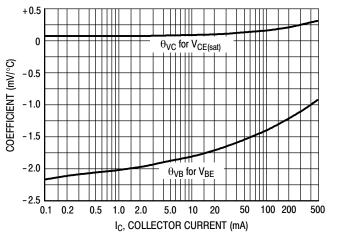
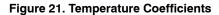


Figure 19. Base Emitter Saturation Voltage vs. Collector Current

Figure 20. Base Emitter Turn-ON Voltage vs. Collector Current





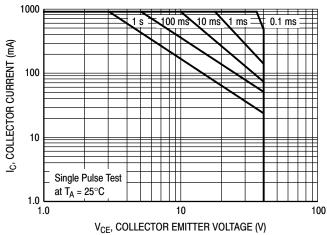
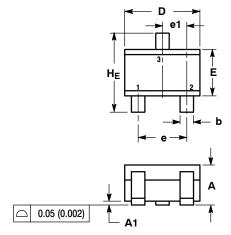


Figure 22. Safe Operating Area

PACKAGE DIMENSIONS

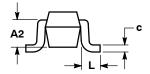
SC-70 (SOT-323) CASE 419-04 ISSUE N



NOTES:

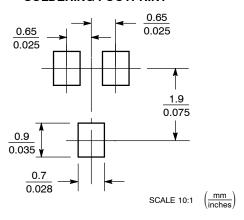
- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.80	0.90	1.00	0.032	0.035	0.040
A1	0.00	0.05	0.10	0.000	0.002	0.004
A2	0.70 REF			0.028 REF		
b	0.30	0.35	0.40	0.012	0.014	0.016
С	0.10	0.18	0.25	0.004	0.007	0.010
D	1.80	2.10	2.20	0.071	0.083	0.087
Е	1.15	1.24	1.35	0.045	0.049	0.053
е	1.20	1.30	1.40	0.047	0.051	0.055
e1	0.65 BSC			0.026 BSC		
L	0.20	0.38	0.56	0.008	0.015	0.022
HE	2.00	2.10	2.40	0.079	0.083	0.095



STYLE 3: PIN 1. BASE 2. EMITTER 3. COLLECTOR

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of SCILLC's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC for each customer application by customer's technical experts. SCILLC for each customer application by customer's technical in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. Thi

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800-282-9855 Toll Free USA/Canada

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center

Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your loca Sales Representative